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1 Introduction

1.1 Overview

This is the user's guide for the TRF1x12 EVM. The TRF1x12 is a receive down-converter with integrated AGC amplifiers and synthesizers for use in a WiMAX system.

1.2 EVM Configuration Options

The EVM can be configured as a TRF1112 or TRF1212. The configuration of the board is marked by a component placed in either the R1112 or R1212 location. The TRF1112 operates in the 2.3 GHz to 2.7 GHz band and the TRF1212 operates in the 3.3 to 3.8 GHz band.



1.3 System Block Diagram

The basic radio system block diagram in Figure 1 demonstrates where the TRF1x12 fits in the overall transceiver. The red box highlights the TRF1x12 device.



Figure 1. System Block Diagram

2 EVM Test Configuration

2.1 Test Block Diagram

The test set-up for general testing of the TRF1x12 is shown in Figure 2.



Figure 2. Test Set-Up Block Diagram



2.2 Test Equipment

The following equipment is required for completing RF Testing:

- Power Supply with Current Readout
 Agilent E3631 or Equivalent
- Signal Generator for input signal
- Spectrum Analyzer
- Computer with Parallel Port

2.3 Calibration

The input/output RF cables should be good quality RF cables due to the high frequency signals.

• Measure the insertion loss of the RF output cable and use this value to compensate for the output power read from the spectrum analyzer when measuring the RF synthesizer output. The insertion loss value can be stored in the analyzer's Reference Level Offset parameter.

Agilent E4438C or Equivalent

Agilent E4440A or Equivalent

• Verify the input signal at the end of the cable connected to the board is at the desired set-point value. If not, adjust for the insertion loss by incrementing the amplitude on the signal generator.

3 Software Control

3.1 Installation Instructions

- Open folder named WiMAX_GUI_Installer_Verx.x.fdr
- Run Setup.exe
- Follow the on-screen instructions

3.2 Software Launch Instructions

- Start the program by clicking on the TI_WIMAX_GUI program
- The main screen appears as in Figure 3.
- Select the TFX1x12 radial button
- The TRF1x12 GUI is launched as seen in Figure 4

3.3 Software Operation

- Select appropriate RX BB Freq. for desired IF2 output frequency. On board SAW filters are centered at 44 MHz
- Select appropriate RX IF VCO Freq. to set the desired RX IF Freq. input
- Select the desired RX RF VCO Freq.
- Filter Select: toggles between the two on-board filters: one with 7 MHz BW and the other with 3.5 MHz BW
- Write Registers: loads the parameters from the screen to the device
- Reference Freq: the EVM has an on-board 18 MHz TCXO hence there is no need to change this value. If an alternate reference is used then this parameter can be changed



Figure 3. WiMAX GUI Front Panel

TRF1x12_GULvi					
Reference Freq. [MHz]	18.000	RX Parity Select Falling Edge	-		
RX RF Freq.[MHz]	3500.000	Castia			
RX IF Freq.[MHz]	456.000	Write Registers	1		
RX BB Freq.[MHz] 🗄	44.000				
RX IF VCO Freq.[MHz]	412.000				
RX RF VCO Freq.[MHz]	3044.000	Quit			

Figure 4. TRF1x12 GUI Front Panel



4 Basic Test Procedure

This section outlines the basic test procedure for testing the EVM. This section is divided into three test sections: DC and Programmability, Basic CW RF, and Modulated WiMAX signals. The first section requires only power supply with current readout and computer for programmability. The second section requires basic RF test equipment and basic technical know-how. The third section is for reference and requires specialized equipment; only sections one and two are required to ensure basic functionality.

4.1 Initial Inspection

• Determine which device is placed on the board by inspecting which jumper resistor is installed at the R1112 and R1212 location.

4.2 DC/Programmability Test

- Connect +5V to J13; connect ground to J14.
- Engage power supplies
- Verify current is 225 ±25 mA
- Launch TI_WiMAX_GUI software
- Select the TRF1x12 radio button
- Verify RX BB Freq. is 44 MHz; verify RX IF VCO Freq. is 412 MHz; verify RX RF VCO Freq. is 3044 MHz (TRF1212) or 1944 (TRF1112)
- Press the Write Registers button
- Verify LEDs D1 and D2 illuminate

4.3 Basic RF Test

- Inject 456 MHz CW signal in at J3 at -55 dBm
- Connect Spectrum Analyzer at J2
- Set Spectrum analyzer center frequency to: 44 MHz; set span to 10 MHz; set reference level to 10 dBm
- Measure signal at 44 MHz and verify signal at -20 dBm ±3 dB
- Change Signal Generator amplitude to -75 dBm
- Measure signal at 44 MHz and verify signal maintains –20 dBm ±3 dB
- Toggle Filter Select Switch; verify that the signal maintains –20 dBm ±3 dB; verify change in the noise floor shape
- Revert switch back to original position
- Move RF output cable to J5
- Change Spectrum Analyzer center frequency to 3044 MHz (TRF1212) or 1944 MHz (TRF1112)
- Measure RF synthesizer output signal; verify level is at –1.5 dBm (TRF1212) or –2.0 dBm (TRF1112) ±2 dB; ensure the RF cable loss is compensated for.

4.4 Modulated RF Performance

- Inject 456 MHz modulated signal in at J3 at -55 dBm
- Connect Spectrum Analyzer at J2 and initiate WiMAX analysis program
- Set Spectrum Analyzer center frequency to: 44 MHz
- Move Jumper at J12 to EXT
- Adjust pot at R64 until output power is -10 dBm ±0.5 dB
- Adjust reference level offset to appropriate range for output signal
- Verify EVM performance is < -40 dB
- Revert jumper at J12 back to INT





Figure 5. TRF1x12 EVM Performance

5 Optional Configurations

5.1 AGC Operation

The EVM can be configured for internal AGC control or external AGC control. The internal control is set by placing jumper J12 to INT. As configured, the set point output is about –19 dBm. This can be modified by adjusting the voltage divider resistors at R58 and R59.

For external AGC control the jumper at J12 is placed at EXT. This will allow the adjustment of the AGC voltage using the pot at R64. In this mode, the AGC voltage will need to be modified for every change in input power to keep the output power consistent.



5.2 External Reference Oscillator

The EVM is configured with a TCXO to provide the 18 MHz reference frequency. If desired, an external reference can be injected at J15. To employ this option the following modifications are required.

- Move C49 to R13 location
- Inject reference frequency at J15

5.3 Differential Inputs

The normal configuration uses transformers and baluns to convert the differential signals to single ended in order to facilitate lab testing. If desired, any of the inputs can be converted to differential operation which may be desirable when cascading one or more of the chipset's EVMs together.

5.3.1 IF Input

- Remove T2
- Place R7: 0 Ω resistor (1210)
- Place R8: 0 Ω resistor
- Differential outputs at J3 and J4

5.3.2 LO Output

- Remove T3
- Jumper across pads of T3 (input to output on each side) using a 0 Ω 0201 resistor
- Place 3.6 pF (TRF1212) or 4.7 pF (TRF1112) at R9
- Differential inputs at J5 and J6

5.3.3 IF2 Output

- Remove T1
- Move R30 to R11 location
- Place R5 and R6 0 Ω 1206 resistors

5.4 External IF2 SAW

The EVM has an option to use an external single ended or differential SAW instead of using the one on the board.

5.4.1 Differential SAW

- Remove L3, L4, C28, C29, R21, R22
- Place R18, R19, R23, R24 with 0 Ω resistor
- External IF SAW inputs connected at J9 and J10; external IF SAW outputs connected to J7 and J8

5.4.2 Single Ended SAW

- Remove L3, L4, C28, C29, R21, R22
- Place R18, R19, R23, R24 with 0 Ω resistor
- Place R20 and R25 with 49.9 Ω resistors
- External IF SAW input connected at J9; external IF SAW output connected to J8

5.5 Split DC Supply

The EVM uses one supply to power the device and the reference oscillator circuitry. If desired, these supplies can be separated so that the true current draw of the device can be measured. To employ this option the following modifications must be done.

- Remove FB9
- Clip 5V lead to TP5 (5V_AUX)

6 Physical Description

This chapter describes the physical characteristics and PCB layout of the EVM and lists the components used on the module.

6.1 Parts List

Table 1 lists the parts used in constructing the EVM.

Qty	Reference	Value	Mfr Name	Part Number	Note
3	C1 C6 C24	0.01µF	AVX	0402YC103KAT2A	
9	C2 C9 C11 C12 C14	3.6pF	Murata	GRM1555C1H3R6CZ01D	TRF1212EVM
	C23 C26 C53 C55	4.7pF	Murata	GRM1555C1H4R7CZ01D	TRF1112EVM
8	C3 C5 C10 C32 C33 C37 C39 C54	220pF	Murata	GRM1555C1H221JA01D	
6	C4 C8 C13 C40 C42 C43	10nF	Murata	GRM155R71C103KA01D	
1	C7	820pF	Murata	GRM155R71H821KA01D	
1	C15	680pF	Murata	GRM155R71H681KA01D	
1	C16	15nF	Murata	GRM155R71C153KA01D	
2	C17 C27	4.7pF	Murata	GRM1555C1H4R7CZ01D	
1	C18	270pF	Murata	GRM1555C1H271JA01D	
2	C19 C20	100pF	AVX	0402A101JAT2A	
2	C21 C51	1000pF	AVX	04025C102KAT2A	
4	C22 C30 C34 C38	100nF	Murata	GRM155R61A104KA01D	
4	C25 C46–C48	1μF	Panasonic	ECJ-0EB1A105M	
1	C28	110pF	Murata	GRM1555C1111JA01D	
1	C29	110pF	Murata	GRM1555C1H111JA01D	
1	C31	470pF	Murata	GRM1555C1H471JA01D	
0	C35	100nF	Murata	GRM155R61A104KA01D	DNI
1	C36	22nF	Murata	GRM155R71E223KA61D	
4	C45 C49 C50 C52	0.1µF	AVX	0402YD104KAT2A	
2	D1 D2	PG1112H-TR	Stanley	PG1112H-TR	
10	FB1–FB10	120	Murata	BLM15AG121SNIB	
1	FL1	3.5MHz BW	TAI-SAW TECHNOLOGY	ТВ0363А	
1	FL2	7MHz BW	TAI-SAW TECHNOLOGY	TB0364A	
11	J1–J10 J15	SMA_END_FLAT	Johnson Components	142-0701-851	
1	J11	CON_DB25_RT_F	AMP	5745536-2	
1	J12	Header_1x3_100	SAMTEC	TSW-103-07-L-S	
1	J13	RED	ALLIED ELECTRONICS	ST-351A	
1	J14	BLK	ALLIED ELECTRONICS	ST-351B	
2	L3 L6	680nH	Coilcraft	0603LS-681XJL	
1	L4	220nH	Coilcraft	0603CS-R22XJL	
1	L5	270nH	Coilcraft	0603CS-R27XJL	

Table 1. TRF1x12 EVM Parts List

Qty	Reference	Value	Mfr Name	Part Number	Note
4	MT1–MT4	STANDOFF	Keystone	1902CK	STANDOFF
0	R5–R7	0	Panasonic	ERJ-8GEY0R00V	DNI
0	R8 R9 R11 R13 R18 R19 R23 R24	0	Panasonic	ERJ-2GE0R00X	DNI
11	R21 R22 R26–R28 R30 R48–R51	0	Panasonic	ERJ-2GE0R00X	
1	R1112	0	Panasonic	ERJ-2GE0R00X	TRF1112EVM
1	R1212	0	Panasonic	ERJ-2GE0R00X	TRF1212EVM
3	R10 R15 R29	100	Panasonic	ERJ-2RKF1000X	
1	R12	1K	Panasonic	ERJ-2GEJ102X	
3	R14 R16 R17	200	Panasonic	ERJ-2RKF2000X	
0	R20 R25	49.9	Panasonic	ERJ-2RKF49R9X	DNI
1	R33	158	Panasonic	ERJ-2RKF1580X	
1	R47	1.5K	Panasonic	ERJ-2RKF1501X	
6	R52 R58 R60–R63	10K	Panasonic	ERJ-2GEJ103X	
2	R53 R54	100K	Panasonic	ERJ-2GEJ104X	
2	R55 R56	51	Panasonic	ERJ-2GEJ510X	
1	R57	24K	Panasonic	ERJ-2GEJ243X	
1	R59	2K	Panasonic	ERJ-2RKF2001X	
0	R68	10K	Panasonic	ERJ-2GEJ103X	DNI
1	R64	10K	BC COMPONENTS	CT94W103	
2	R65 R66	240	Panasonic	ERJ-2GEJ241X	
1	T1	ADT16-1T	Minicircuits	ADT16-1T	
1	T2	JTX-2-10T	Minicircuits	JTX-2-10T	
1	Т3	3150MHz	Anaren	BD3150L50100A00	TRF1212 EVM
		2326MHz	Anaren	BD2326J50100A00	TRF1112 EVM
6	TP1–TP6	Red	Keystone	5000	
1	TP7	Blk	Keystone	5001	
1	U1	TRF1112	TI	TRF1112	TRF1112 EVM
1	U1	TRF1212	TI	TRF1212	TRF1212 EVM
1	U3	LM2904D	TI	LM2904D	
1	U4	74HCT125	TI	SN74HCT125D	
1	Y1	18MHz	Vectron	VTC1-A0CE-18M000	

Table 1. TRF1x12 EVM Parts List (continued)



6.2 PCB Layout and Schematics

The EVM is constructed on a 4-layer, 3.25-inch \times 3.25-inch, 0.062-inch thick PCB using FR4-170 material. Figure 6 through Figure 9 show the PCB layout for the EVM and the schematics.



Figure 6. Top Layer 1





Figure 7. Ground Plane Layer 2



Figure 8. Power Plane Layer 3

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Figure 9. Bottom Layer 4





























SERIAL INTERFACE & LOCK DETECT PORT



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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 0 V to 5 V and the output voltage range of 0 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85 C. The EVM is designed to operate properly with certain components above 85 C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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